



Customer No.: 31561
Application No.: 10/064,061
Docket NO.: 8941-US-PA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:)
Application No.: 10/064,061)
Filed: June 6, 2002)
For: Flip-Chip Package Substrate)

Applicant: Hsu et al.)
Examiner: Norris, Jeremy C)
Art Unit 2827)

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 8941-US-PA)

U.S. Patent and Trademark Office
Commissioner for Patents
2011 South Clark Place
Customer Window, Mail Stop **Non-Fee Amendment**
Crystal Plaza Two, Lobby, Room 1B03
Arlington, Virginia 22202

Sir:

In response to the Office Action dated March 12, 2003, please enter the following amendments and consider the following remarks.

No fee is believed to be due in connection with this amendment and response to Office Action. If, however, any fee is believed to be due, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No. JCLA8941)

IN THE CLAIMS

Please amend the claims as follows.

1. (Currently Amended) A flip-chip package substrate, comprising: